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| APPLICATION NO.                         | FILING DATE     | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO.           | CONFIRMATION NO |
|---|-----------------|----------------------|-------------------------------|-----------------|
| 09/486,561                              | 02/29/2000      | NOBUAKI HASHIMOTO    | 105030                        | 8576            |
| 25944                                   | 7590 08/24/2004 |                      | EXAMINER                      |                 |
| OLIFF & BERRIDGE, PLC<br>P.O. BOX 19928 |                 |                      | ZARNEKE, DAVID A              |                 |
| ALEXANDRIA, VA 22320                    |                 |                      | ART UNIT                      | PAPER NUMBER    |
|   |                 |                      | 2829  DATE MAILED: 08/24/2004 |                 |
|   |                 |                      |                               |                 |

Please find below and/or attached an Office communication concerning this application or proceeding.

|   | · · · · · · · · · · · · · · · · · · ·   |  | 1.4 - 10 - 17 -  |  |  |  |
|---|---|--|--|--|--|--|
|   |   | Application No.  | Applicant(s)   |  |  |  |
| Office Action Summary   |   | 09/486,561   | HASHIMOTO, NOBUAKI   |  |  |  |
|   |   | Examiner   | Art Unit   |  |  |  |
|   |   | David A. Zarneke   | 2829   |  |  |  |
| Period fo   | The MAILING DATE of this communication a<br>or Reply  | appears on the cover sheet with the  | ne correspondence address  |  |  |  |
| THE - Exte after - If the - If NO - Failu Any   | ORTENED STATUTORY PERIOD FOR REF MAILING DATE OF THIS COMMUNICATION MAILING DATE OF THIS COMMUNICATION (SIX (6) MONTHS from the mailing date of this communication. It period for reply specified above is less than thirty (30) days, a solution of the period for reply is specified above, the maximum statutory perion to reply within the set or extended period for reply will, by state to reply within the set or extended period for reply will, by state ply received by the Office later than three months after the material part of the property | N. 1.136(a). In no event, however, may a reply by the reply within the statutory minimum of thirty (30) od will apply and will expire SIX (6) MONTHS tute, cause the application to become ABAND   | pe timely filed ) days will be considered timely. from the mailing date of this communication. ONED (35 U.S.C. § 133). |  |  |  |
| Status  |   |  |  |  |  |  |
| 1)⊠   | Responsive to communication(s) filed on 08 July 2004.   |  |  |  |  |  |
| 2a) <u></u> ☐   | This action is <b>FINAL</b> . 2b)⊠ This action is non-final.  |  |  |  |  |  |
| 3)□   | Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.   |  |  |  |  |  |
| Dispositi   | on of Claims  |  |  |  |  |  |
| 5)□<br>6)⊠<br>7)□   | Claim(s) <u>1,2,5-8,11,12,14-16 and 21-26</u> is/a 4a) Of the above claim(s) <u>1,2,5-7 and 23</u> is/a Claim(s) is/are allowed. Claim(s) <u>8,11,12,14-16,21,22 and 24-26</u> is/a Claim(s) is/are objected to. Claim(s) are subject to restriction and  | are withdrawn from consideration are rejected.   | I.   |  |  |  |
| Applicati   | on Papers   |  |  |  |  |  |
| 9)[   | The specification is objected to by the Exami   | iner.  |  |  |  |  |
| 10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner. |   |  |  |  |  |  |
|   | Applicant may not request that any objection to the   | •  | • •  |  |  |  |
| 11)   | Replacement drawing sheet(s) including the corr<br>The oath or declaration is objected to by the  |  | · · ·  |  |  |  |
| Priority ι  | ınder 35 U.S.C. § 119   |  |  |  |  |  |
| 12)□<br>a)l   | Acknowledgment is made of a claim for forei  All b) Some * c) None of:  1. Certified copies of the priority docume  2. Certified copies of the priority docume  3. Copies of the certified copies of the priority docume  application from the International Bure  see the attached detailed Office action for a life   | ents have been received. ents have been received in Application of the contract of the contrac | cation No eived in this National Stage   |  |  |  |
| Attachmen   |   |  |  |  |  |  |
| 1) X Notic<br>2) Notic  | e of References Cited (PTO-892)<br>e of Draftsperson's Patent Drawing Review (PTO-948)  | 4) Interview Summ  |  |  |  |  |
| 3) 🔲 Inforr   | e of Dransperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO-1449 or PTO/SB/0 r No(s)/Mail Date   | Paper No(s)/Ma 5) Notice of Inform 6) Other:   | nal Patent Application (PTO-152)   |  |  |  |

## **DETAILED ACTION**

#### Continued Examination Under 37 CFR 1.114

A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 7/8/04 has been entered.

# Response to Arguments

Applicant's arguments with respect to claims 8, 11, 12, 14-16, 21 and 22 have been considered but are most in view of the new ground(s) of rejection.

Claims 1, 2, 5-8, 11, 12, 14-16 and 21-26 are pending and claims 1, 2, 5-7, and 23 have been withdrawn from consideration.

# Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

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The factual inquiries set forth in *Graham* v. *John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:

1. Determining the scope and contents of the prior art.

- 2. Ascertaining the differences between the prior art and the claims at issue.
- 3. Resolving the level of ordinary skill in the pertinent art.
- 4. Considering objective evidence present in the application indicating obviousness or nonobviousness.

Claims 8, 14-16, 21, 22, 24-26 are rejected under 35 U.S.C. 103(a) as being unpatentable over Watanabe, US Patent 6,077,382, in view of Dibble et al., US Patent 6,040,631.

Watanabe teaches a semiconductor device, comprising:

a semiconductor chip having electrodes;

a substrate having an interconnect pattern; and an adhesive, said adhesive having conductive particles dispersed therein;

wherein said electrodes and said interconnect pattern are electrically connected via at least part of said conductive particles of said adhesive; and

wherein said adhesive is interposed between a surface of said substrate on which said interconnect pattern is formed and a surface of said semiconductor chip on which said electrodes are formed, and said adhesive covers substantially all area of lateral surfaces of said semiconductor chip that is substantially perpendicular to the surface of the semiconductor chip on which the electrodes are formed (figures 1-4, 4-4, 6, &/or 7-4).

Watanabe, which teaches the adhesive covers **substantially** all, fails to teach the adhesive covers **all** area of lateral surfaces of said semiconductor chip that is substantially perpendicular to the surface of the semiconductor chip on which the electrodes are formed.

Dibble teaches a chip attached to a substrate using a two adhesive system wherein the adhesive system covers all of the lateral surfaces of said semiconductor chip that is substantially perpendicular to the surface of the semiconductor chip on which the electrodes are formed (Figure 2).

It would have been obvious to one of ordinary skill in the art at the time of the invention to use the adhesive of Dibble in the invention of Watanabe because the adhesive system of Dibble obviously increased the strength of the bond by increasing the surface area that the adhesive covers.

Regarding claims 16, 21 and 22, Watanabe teaches at least a part of said adhesive having a thickness substantially the same as said semiconductor chip. In teaching the side surfaces of the chip are substantially covered, Watanabe inherently teaches at least part of the adhesive as being substantially as thick as the chip.

With respect to claims 24-26, Dibble teaches a part of said adhesive covering substantially all area of said lateral surfaces of said semiconductor chip has part of said conductive particles dispersed therein.

Claim 11 is rejected under 35 U.S.C. 103(a) as being unpatentable over Watanabe, US Patent 6,077,382, in view of Dibble et al., US Patent 6,040,631, as applied to claim 8 above, and further in view of Tsukagoshi et al., US Patent 5,804,882.

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Watanabe and Dibble fail to teach the adhesive as being provided to cover said interconnect pattern in its entirety.

Tsukagoshi teaches an adhesive having conductive particles dispersed therein wherein the adhesive as being provided to cover said interconnect pattern in its entirety (Figures 1-4).

It would have been obvious to one of ordinary skill in the art at the time of the invention to use the adhesive coverage of Tsukagoshi in the invention of Watanabe because it is merely a matter an obvious matter of design choice. Design choices and changes of size are generally recognized as being within the level of ordinary skill in the art (MPEP 2144.04(d)). A skilled artisan would know to cover the entire interconnect pattern because it would ensure a complete electrical connection between the chip and the substrate.

Claim 12 is rejected under 35 U.S.C. 103(a) as being unpatentable over Watanabe, US Patent 6,077,382, in view of Dibble et al., US Patent 6,040,631, as applied to claim 8 above, and further in view of Canning et al., US Patent 5,783,465.

Watanabe and Dibble fail to teach the adhesive as including a shading material.

Canning teaches adding a pigment material (shading material) to an ACF film (5, 14+).

It would have been obvious to one of ordinary skill in the art to use the pigment of Canning in the invention of Watanabe because Canning teaches the conventionality of using a pigment in an ACF film. Pigments, or shading materials, are useful in films to provide color to the film or to reflect light away from sensitive materials.

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The use of conventional materials to perform there known functions in a conventional process is obvious (*In re Aller* 220 F.2d 454,456,105 USPQ 233,235 (CCPA 1955)).

## **Conclusion**

Any inquiry concerning this communication or earlier communications from the examiner should be directed to David A. Zarneke whose telephone number is (571)-272-1937. The examiner can normally be reached on M-F 7:30 AM-6 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Tokar can be reached on (571)-272-1812. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Primary Examiner August 23, 2004